# 1.6mm width contributes to thinner devices





# Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10 µA 1V DC
Initial contact resistance	500mΩ max.
Travel (mm)	0.11
Protective structure **	IP67 equivalent

## ■ Product Line

Product No.	Operating force	Operating direction	n Operating life (5mA 5V DC)	Minimum order unit (pcs.)		Drawing
T TOUGGE NO.	Operating force	Operating direction		Japan	Export	No.
SKTAACE010	1.ON	Top push	300,000cycles	20.000	20.000	1
SKTAAAE010	1.6N	τορ ρασιτ	300,000cycles	20,000	20,000	'

# Packing Specifications

## Taping

Numbe	Tape width	Export package		
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
20,000	200,000	200,000	12	395×395×205

# Reel size

## Note

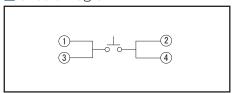
For reels of 330mm diameter, please inquire.

### Dimensions

וווט	nensions	Unit:mm
No.	Style	PC board mounting hole and land dimensions (Viewed from switch mounting face)
1	3 2.6 20 3	3.2 2.1

**ALPS/ILPINE** 

## ■ Circuit Diagram



- \* Assumes the switch is left alone without being operated. Under the specified conditions, dust and water ingress with a significant impact on the switch's on-off function is prevented.
- IP67-level dust and water resistance is guaranteed for the switch alone and performance may not be guaranteed depending on the mounting conditions and usage.

	Ty	ype -	Sharp Feeling Type							
_						Surface Mount				
	Se	eries	SKSD	SKRN	SKTA	SKSV	SKSW	SKTK	SKSG	
	Ph	noto	-		0	0		0	•	
	Fea	tures	Double	action		Compact size Low-profile		Long life	High operation force Compact size	
	Wate	er-proof	_	_	•	•	•	•	_	
	Dus	tproof	_	_	•	•	•	•	_	
	IP sta	andard	_	_	67 equivalent	67 equivalent	67 equivalent 68 equivalent in some cases	67 equivalent	_	
Operatir	ng	Top push	•	•	•	•	•	•	•	
directio	on	Side push	_	_	_	_	_	_	_	
		W	4.1		2.6	2.8	3	5.9	3	
Dimensio (mm)		D	3.9	□6	1.6	1.9	2	4	2.7	
		Н	0.6	0.9	0.53	0.5	0.6	0.78	1.4	
Operation force coverage		1N max. 1N to 2N 2N to 3N 3N to 4N 4N to 5N	See the rele for respect descri		<b>*</b>	1	1	<b>\$</b>	1	
Travel (mm) Ground terminal		See the relev respective prod		0.11	0.12	See the relevant pages for respective product descriptions	0.25	0.12		
		terminal	•	•	_	_	_	_	0	
Operatin	ng tem	nperature range	-40°C t	o +90°C		-30°C t	to +85°C		-40℃ to +85℃	
А	utomo	otive use	_	_	_	_	_	_	•	
	Life	Cycle	<b>*</b> 2	<b>*</b> 2	*3	*3	*3	<b>*</b> 2	<b>*</b> 2	
		Rating (max.) Resistive load)				50mA 12V DC				
Electrical	(F	Rating (min.) Resistive load)	10μA 1V DC							
performance	Insul	lation resistance	100MΩ min. 100V DC 1min.							
	\	/oltage proof	100V AC 1min. 250V AC 1min. 100V AC 1min.							
Durability		Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively							
_ a.aəmey		Lifetime	Shall be in accordance with individual specifications.							
Cold −40°C 96h										
Environmental performance		Dry heat	90°C 96h							
		Damp heat	60℃, 90 to 95%RH 96h							
	Pa	age	195	196	197	198	199	201	202	

Sharp Feeling Type

#### Notes

W : Width. The most outer dimension excluding terminal portion. D : Depth. The most outer dimension excluding terminal portion.

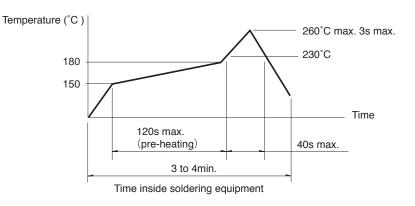
H: Height. The minimum dimension if there are variances.

<sup>1.</sup> The automotive operating temperature range to be individually discussed upon request.

<sup>2.</sup> Indicates applicability to all products in the series, while O indicates applicability to some products in the series.

# ■ Condition for Reflow Available for Surface Mount Type.

Temperature profile



TACT Switch™ / Soldering Conditions

# Notes

- 1. Please confirm the specifications of our product for the detailed condition.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

# ■ Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

## **SKHH Series**

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

## SKHLTop Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

# ■ Manual Soldering

Items		Condition
Soldering temperature		350°C max.
Duration of soldering		3s max.
	Capacity of soldering iron	60W max.

## SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

#### SKTD, SKTG, SKQJ, SKSN Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

# Notes

- 1. Prevent flux penetration from the top side of the TACT Switch™.
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA CORPORATION, or equivalents.)

